5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	В	base	mb	С
2	С	collector		В
3	E	emitter		
mb	n.c.	isolated	1 2 3 TO-220F (SOT186A)	Ë sym123

6. Ordering information

Table 3. Ordering information

Type number	Package				
	Name	Description	Version		
BUJ302AX	TO-220F	plastic single-ended package; isolated heatsink mounted; 1 mounting hole; 3-lead TO-220 "full pack"	SOT186A		

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CESM}	collector-emitter peak voltage	V _{BE} = 0 V	-	1050	V
V_{CEO}	collector-emitter voltage	I _B = 0 A	-	400	V
V _{EBO}	emitter-base voltage	$I_C = 0 \text{ A}; I_E = 2 \text{ A}; t_p < 10 \text{ ms}$	-	24	V
I _C	collector current	Fig. 1; Fig. 2; Fig. 3	-	4	Α
I _{CM}	peak collector current		-	8	Α
I _B	base current	DC	-	2	Α
I _{BM}	peak base current		-	4	Α
P _{tot}	total power dissipation	T _h ≤ 25 °C; <u>Fig. 4</u>	-	26	W
T _{stg}	storage temperature		-65	150	°C
Tj	junction temperature		-	150	°C

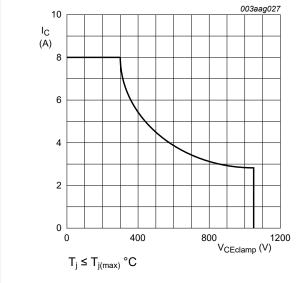
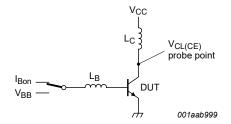
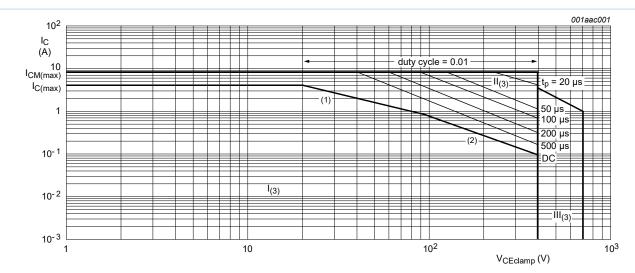


Fig. 1. Reverse bias safe operating area



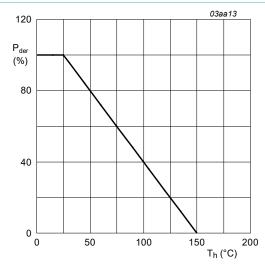
$$\begin{split} &V_{CL(CE)} \leq 1000 \text{ V}; \text{ } V_{CC} = 150 \text{ V}; \text{ } V_{BB} = \text{--} 5 \text{ V}; \\ &L_{B} = 1 \text{ } \mu\text{H}; \text{ } L_{C} = 200 \text{ } \mu\text{H} \end{split}$$

Fig. 2. Test circuit for reverse bias safe operating area



- 1) Ptot maximum and Ptot peak maximum lines
- 2) Second breakdown limits
- 3) I = Region of permissable DC operation
 - II = Extension for repetitive pulse operation
 - III = Extension during turn-on in single transistor converters provided that $R_{BE} \le 100~\Omega$ and $t_p \le 0.6~\mu s$

Fig. 3. Forward bias safe operating area for $T_{mb} \le 25~^{\circ}\text{C}$



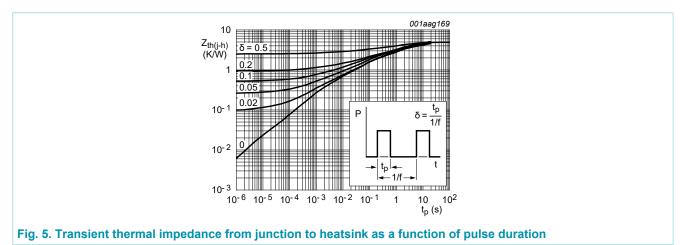
$$P_{der} = \frac{P_{tot}}{P_{tot}(25^{\circ}C)} \times 100\%$$

Fig. 4. Normalized total power dissipation as a function of heatsink temperature

8. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-h)}	thermal resistance from junction to heatsink	with heatsink compound; Fig. 5	-	-	4.8	K/W
R _{th(j-a)}	thermal resistance from junction to ambient free air	in free air	-	55	-	K/W



9. Isolation characteristics

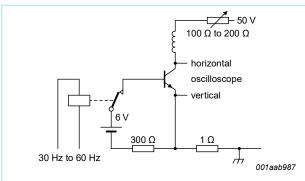
Table 6. Isolation characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{isol(RMS)}	RMS isolation voltage	50 Hz \leq f \leq 60 Hz; RH \leq 65 %; T _h = 25 °C; from all terminals to external heatsink; clean and dust free	-	-	2500	V
C _{isol}	isolation capacitance	from collector to external heatsink; $f = 1 \text{ MHz}$; $T_h = 25 ^{\circ}\text{C}$	-	10	-	pF

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	acteristics					
I _{CES}	collector-emitter cut-off current (base shorted)	$V_{BE} = 0 \text{ V}; V_{CE} = 1050 \text{ V}; T_j = 25 \text{ °C}$	-	0.2	10	μΑ
I _{CEO}	collector-emitter cut-off current (base open)	$V_{CE} = 400 \text{ V}; I_B = 0 \text{ A}; T_h = 25 \text{ °C}$	-	10	250	μΑ
$V_{(BR)EBO}$	emitter-base breakdown voltage (collector open)	$I_B = 1 \text{ mA}; I_C = 0 \text{ A}; T_h = 25 \text{ °C}$	15	19	-	V
V_{CEOsus}	collector-emitter sustaining voltage (base open)	$I_B = 0 \text{ A}; I_C = 10 \text{ mA}; L_C = 25 \text{ mH};$ $T_h = 25 ^{\circ}\text{C}; \frac{\text{Fig. 6}}{\text{Fig. 7}}; \frac{7}{\text{Fig. 7}}$	400	470	-	V
V _{CEsat}	collector-emitter saturation voltage	$I_C = 1 \text{ A}$; $I_B = 0.2 \text{ A}$; $T_h = 25 \text{ °C}$; <u>Fig. 8</u> ; <u>Fig. 9</u>	-	0.15	0.5	V
		$I_C = 3.5 \text{ A}$; $I_B = 1 \text{ A}$; $T_h = 25 \text{ °C}$; Fig. 8; Fig. 9	-	0.6	1.5	V
V _{BEsat}	base-emitter saturation voltage	$I_C = 3.5 \text{ A}$; $I_B = 1 \text{ A}$; $T_h = 25 \text{ °C}$; Fig. 10	-	1.1	1.5	V
h _{FE}	DC current gain	$I_C = 0.1 \text{ A}; V_{CE} = 5 \text{ V}; T_h = 25 ^{\circ}\text{C};$ Fig. 11	48	66	100	
		$I_C = 0.8 \text{ A}; V_{CE} = 3 \text{ V}; T_h = 25 ^{\circ}\text{C};$ Fig. 12	25	42	50	
Dynamic ch	aracteristics					
t _s	storage time	I _C = 2.5 A; I _{Bon} = 0.5 A; I _{Boff} = -0.5 A;	-	-	3.5	μs
t _f	fall time	$R_L = 60 \Omega$; $V_{BB} = -5 V$; $T_h = 25 ^{\circ}C$; resistive load; $t_p = 300 \mu s$; $Fig. 13$; $Fig. 14$	-	-	500	ns





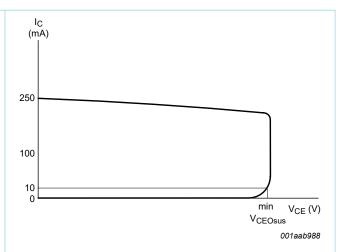


Fig. 7. Oscilloscope display for collector-emitter sustaining voltage test waveform

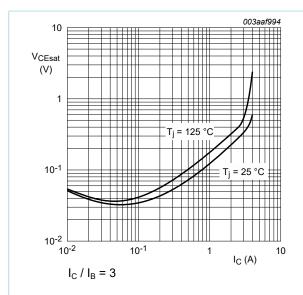


Fig. 8. Collector-emitter saturation voltage as a function of collector current; typical values

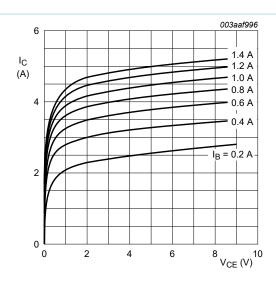


Fig. 9. Collector current as a function of collectoremitter voltage; typical values

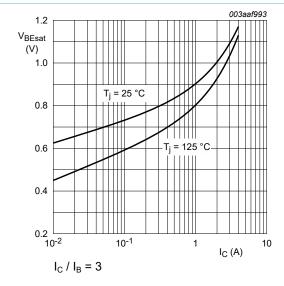


Fig. 10. Base-emitter saturation voltage as a function of collector current; typical values

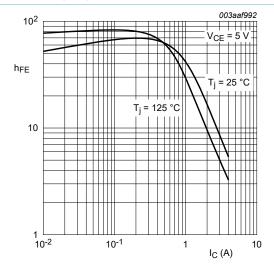


Fig. 11. DC current gain as a function of collector current; typical values

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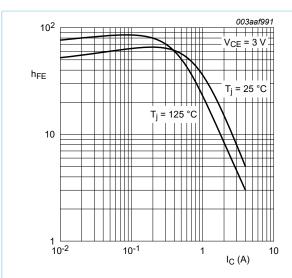


Fig. 12. DC current gain as a function of collector current; typical values

$$V_{CC}$$
 V_{IM}
 V_{DM}
 V

 $V_{IM}\text{= -6 to + 8 V; }V_{CC}\text{= 250 V; }t_p\text{= 20 us; }\delta\text{= }t_p\text{/T = 0.01}$ R_B and R_L calculated from I_{Con} and I_{Bon} requirements.

Fig. 13. Test circuit for resistive load switching

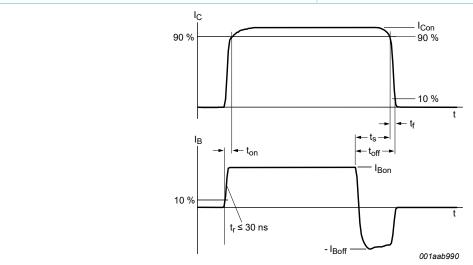
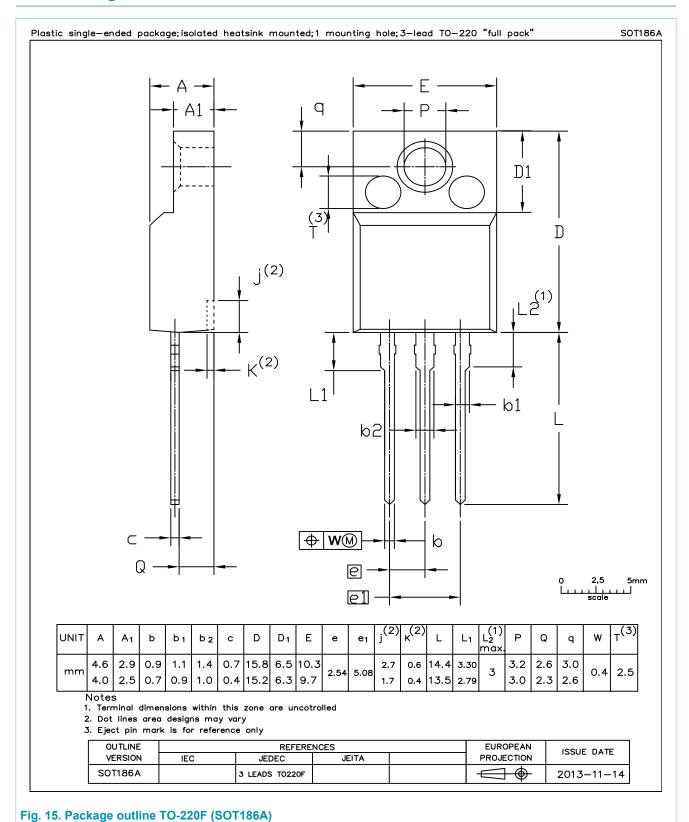


Fig. 14. Switching times waveforms for resistive load

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11. Package outline



12. Legal information

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